Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}	50	V
Collector-base voltage	V_{CBO}	50	
Input forward voltage	$V_{i(fwd)}$	40	
Input reverse voltage	$V_{i(rev)}$	6	
Collector current	I_C	100	mA
Total power dissipation	P_{tot}		mW
BCR135, $T_S \leq 102°C$		200	
BCR135S, $T_S \leq 115°C$		250	
BCR135W, $T_S \leq 124°C$		250	
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-65 ... 150	

Thermal Resistance

Parameter	Symbol	Value	Unit
Junction - soldering point[1)]	R_{thJS}		K/W
BCR135		≤ 240	
BCR135S		≤ 140	
BCR135W		≤ 105	

[1]For calculation of R_{thJA} please refer to Application Note AN077 (Thermal Resistance Calculation)

Downloaded from Arrow.com.

Electrical Characteristics at T_A = 25°C, unless otherwise specified

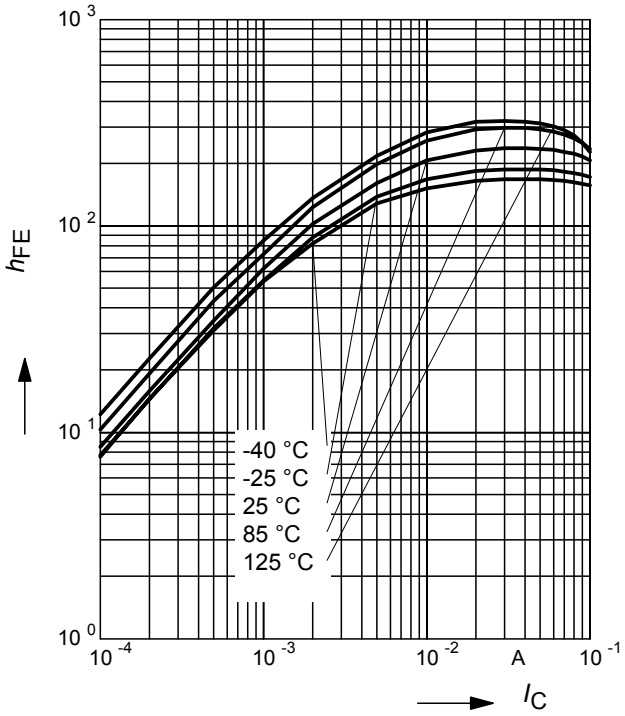
Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics					
Collector-emitter breakdown voltage I_C = 100 µA, I_B = 0	$V_{(BR)CEO}$	50	-	-	V
Collector-base breakdown voltage I_C = 10 µA, I_E = 0	$V_{(BR)CBO}$	50	-	-	
Collector-base cutoff current V_{CB} = 40 V, I_E = 0	I_{CBO}	-	-	100	nA
Emitter-base cutoff current V_{EB} = 6 V, I_C = 0	I_{EBO}	-	-	167	µA
DC current gain[1)] I_C = 5 mA, V_{CE} = 5 V	h_{FE}	70	-	-	-
Collector-emitter saturation voltage[1)] I_C = 10 mA, I_B = 0.5 mA	V_{CEsat}	-	-	0.3	V
Input off voltage I_C = 100 µA, V_{CE} = 5 V	$V_{i(off)}$	0.5	-	1	
Input on voltage I_C = 2 mA, V_{CE} = 0.3 V	$V_{i(on)}$	0.5	-	1.4	
Input resistor	R_1	7	10	13	kΩ
Resistor ratio	R_1/R_2	0.19	0.21	0.24	-
AC Characteristics					
Transition frequency I_C = 10 mA, V_{CE} = 5 V, f = 100 MHz	f_T	-	150	-	MHz
Collector-base capacitance V_{CB} = 10 V, f = 1 MHz	C_{cb}	-	3	-	pF

[1]Pulse test: t < 300µs; D < 2%

Downloaded from Arrow.com.

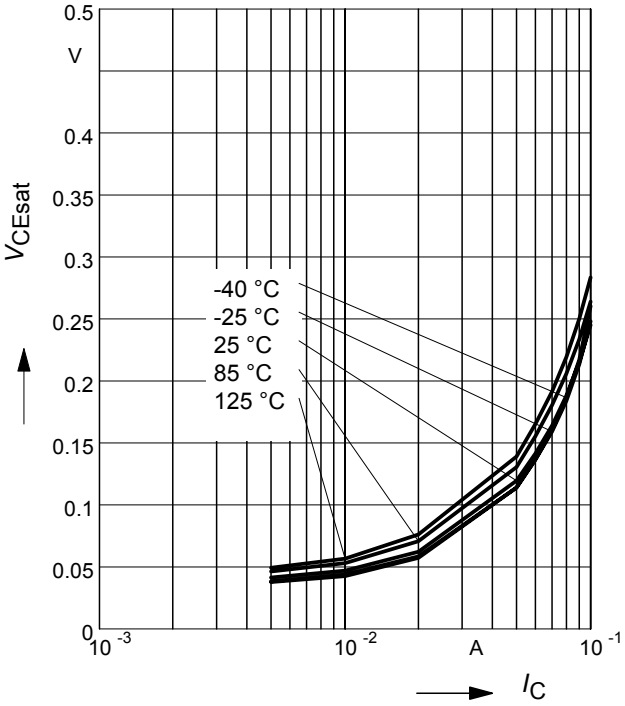
DC current gain h_{FE} = $f(I_C)$

V_{CE} = 5V (common emitter configuration)



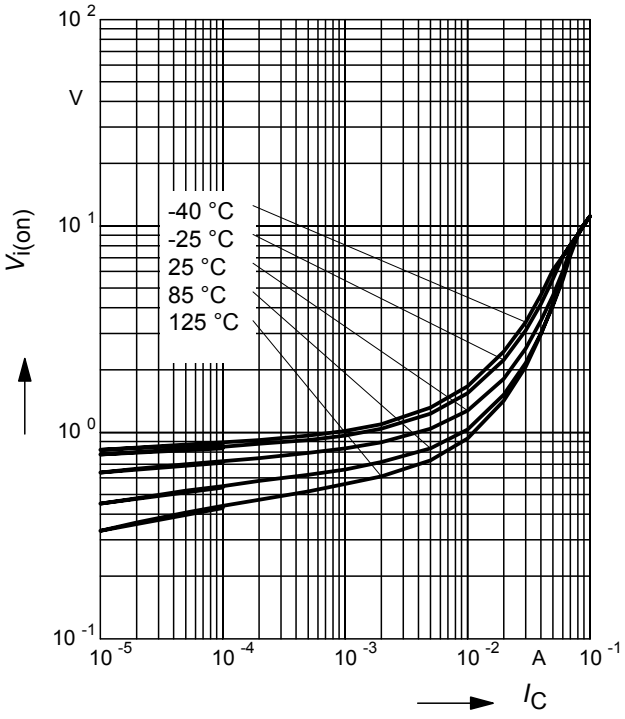
Collector-emitter saturation voltage

V_{CEsat} = $f(I_C)$, I_C/I_B = 20



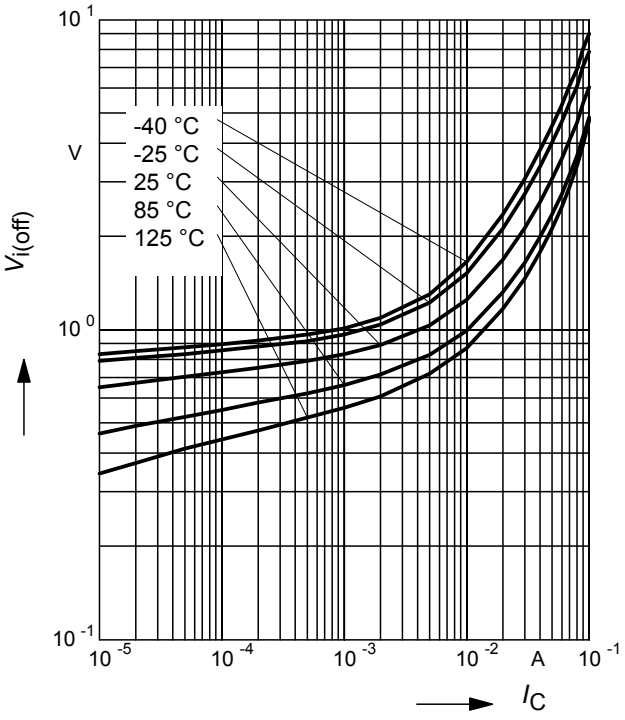
Input on Voltage $V_{i(on)}$ = $f(I_C)$

V_{CE} = 0.3V (common emitter configuration)



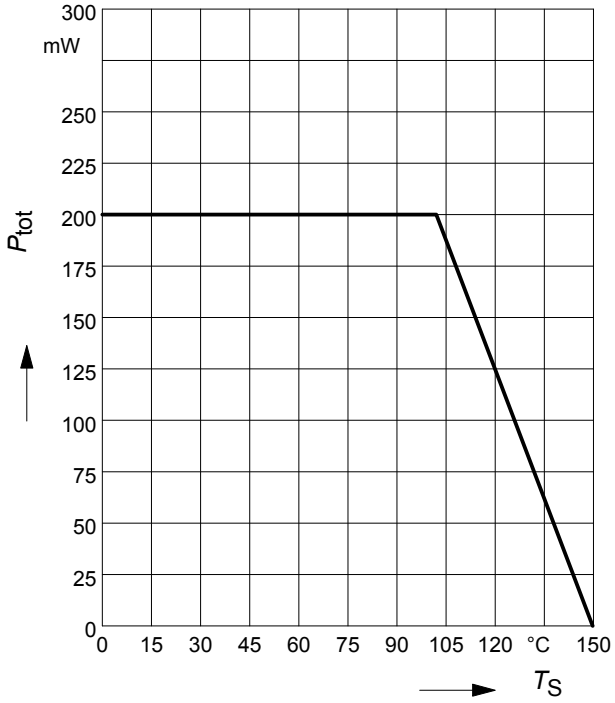
Input off voltage $V_{i(off)}$ = $f(I_C)$

V_{CE} = 5V (common emitter configuration)

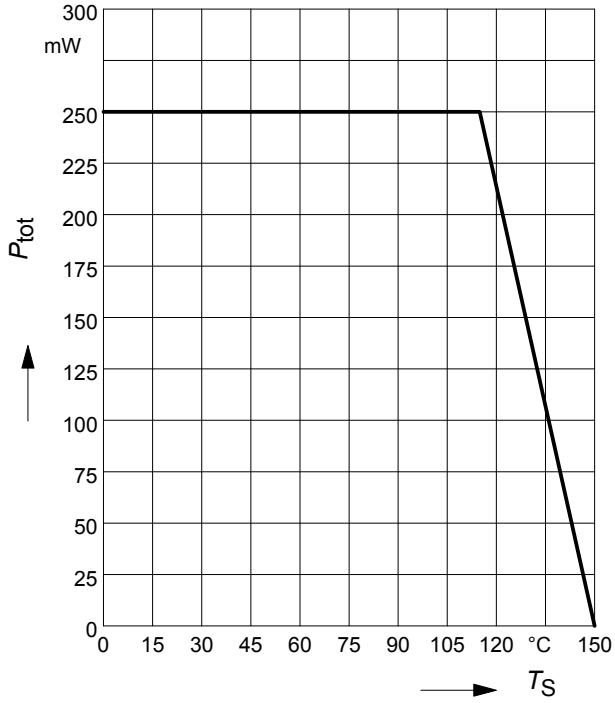


Downloaded from Arrow.com.

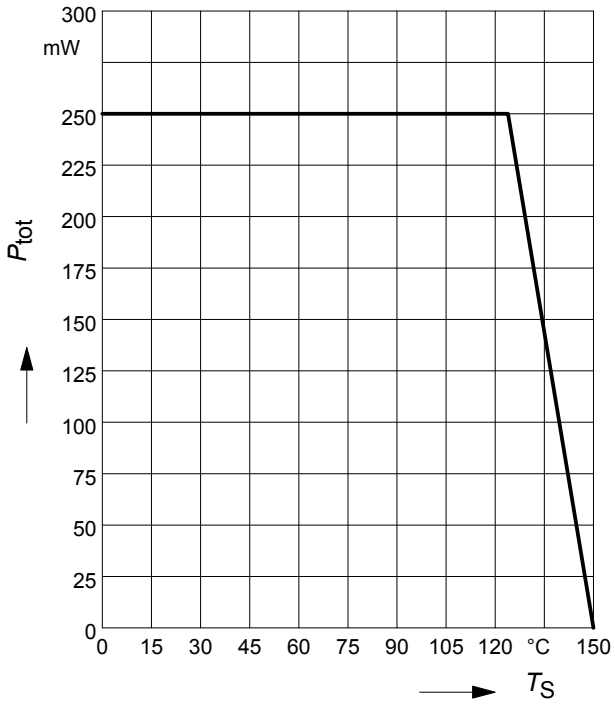
Total power dissipation $P_{tot} = f(T_S)$
BCR135



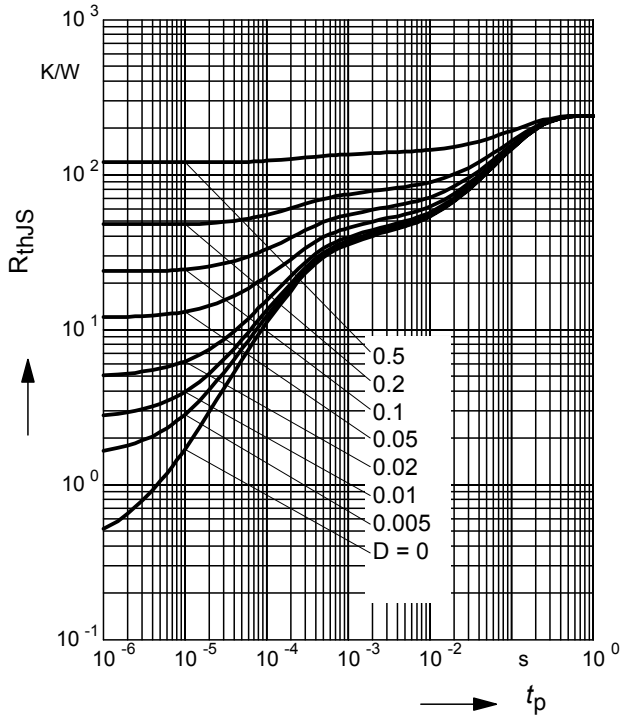
Total power dissipation $P_{tot} = f(T_S)$
BCR135S



Total power dissipation $P_{tot} = f(T_S)$
BCR135W



Permissible Pulse Load $R_{thJS} = f(t_p)$
BCR135

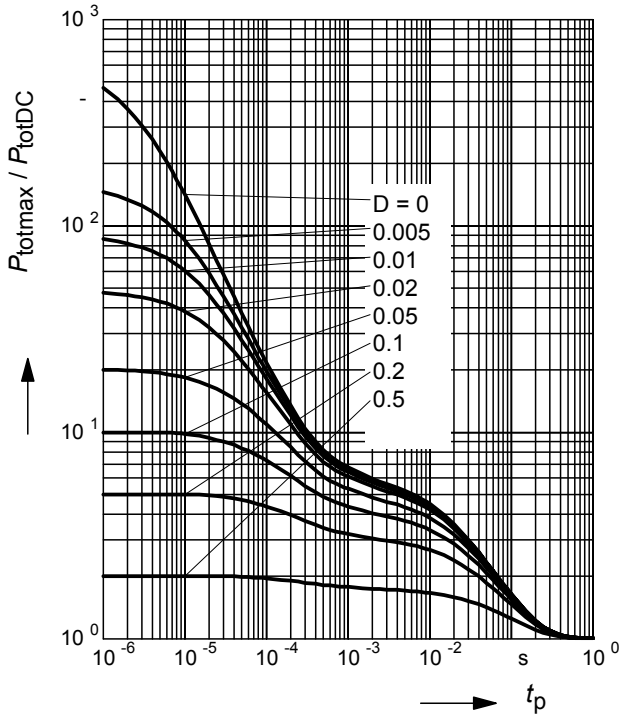


Downloaded from Arrow.com.

Permissible Pulse Load

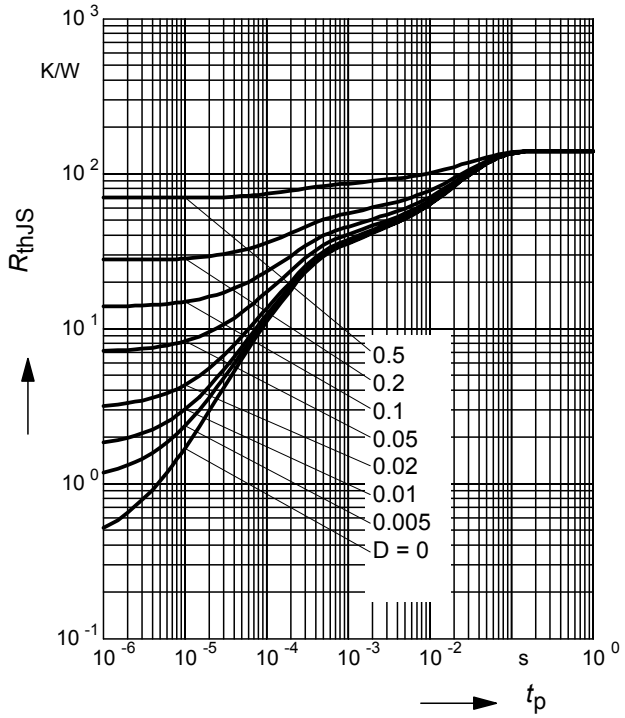
$P_{totmax}/P_{totDC} = f(t_p)$

BCR135



Permissible Puls Load $R_{thJS} = f(t_p)$

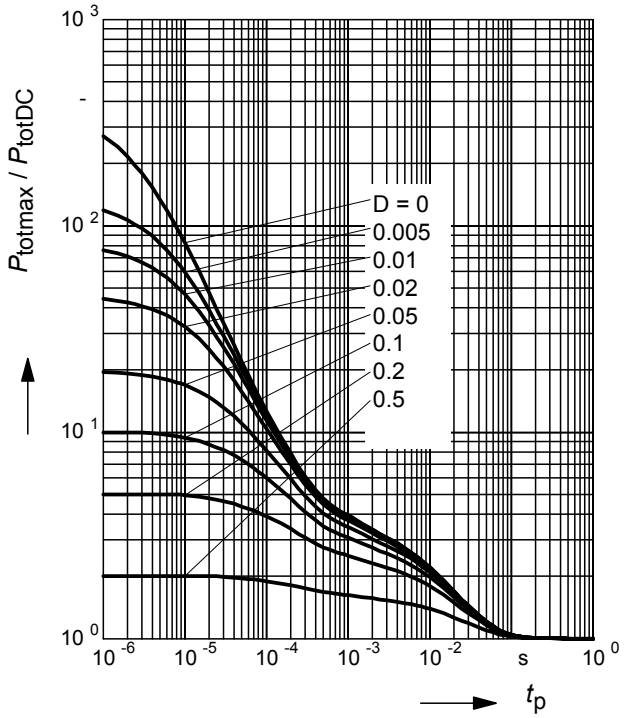
BCR135S



Permissible Pulse Load

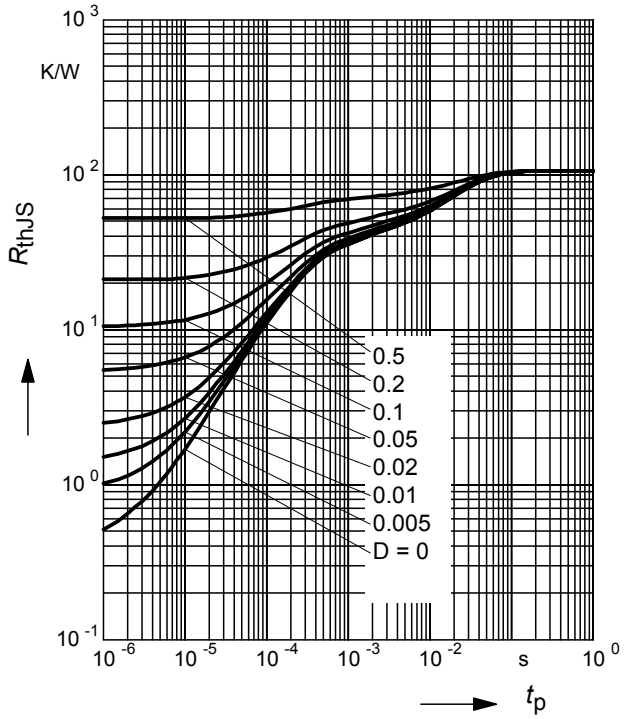
$P_{totmax}/P_{totDC} = f(t_p)$

BCR135S



Permissible Puls Load $R_{thJS} = f(t_p)$

BCR135W

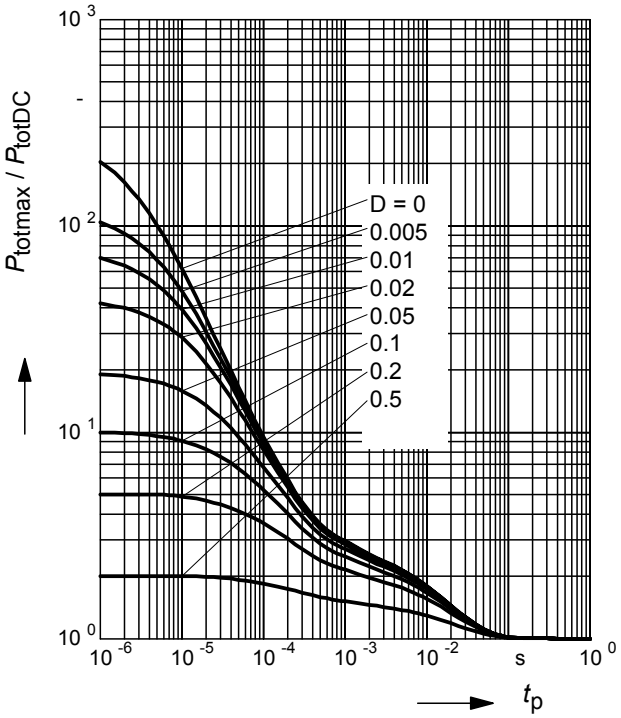


Downloaded from Arrow.com.

Permissible Pulse Load

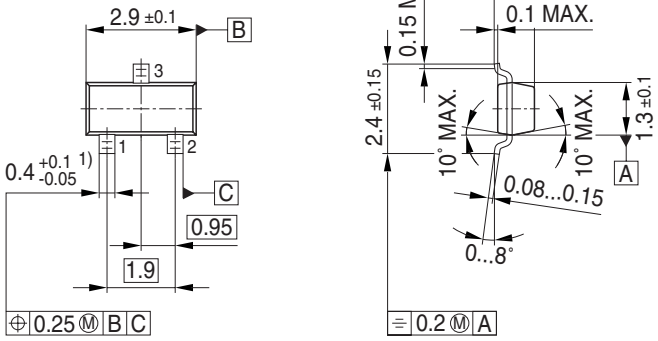
$P_{totmax}/P_{totDC} = f(t_p)$

BCR135W



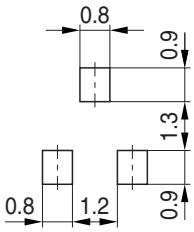
Downloaded from Arrow.com.

Package Outline

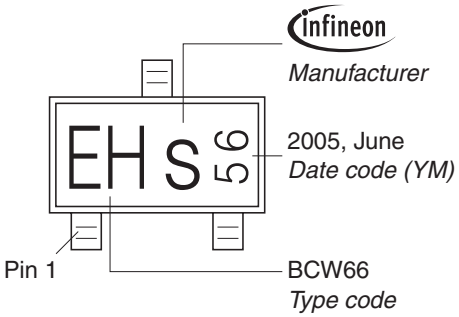


1) Lead width can be 0.6 max. in dambar area

Foot Print

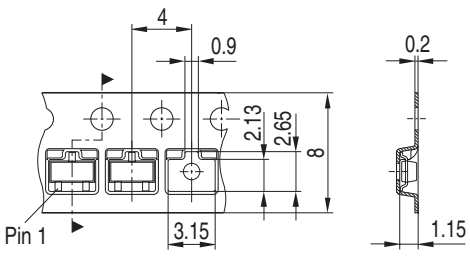


Marking Layout (Example)



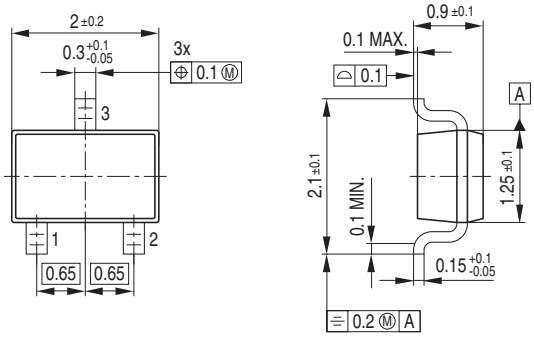
Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel

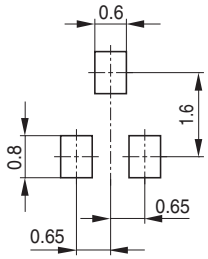


Downloaded from Arrow.com.

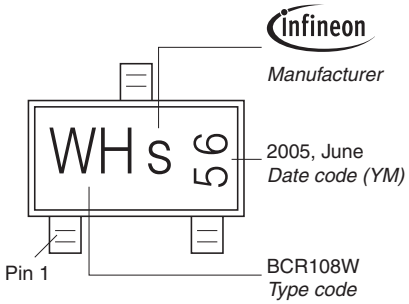
Package Outline



Foot Print

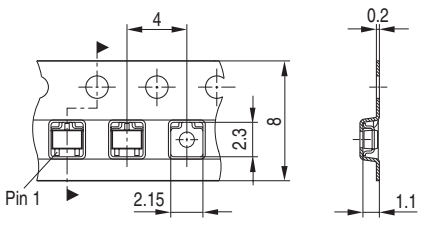


Marking Layout (Example)



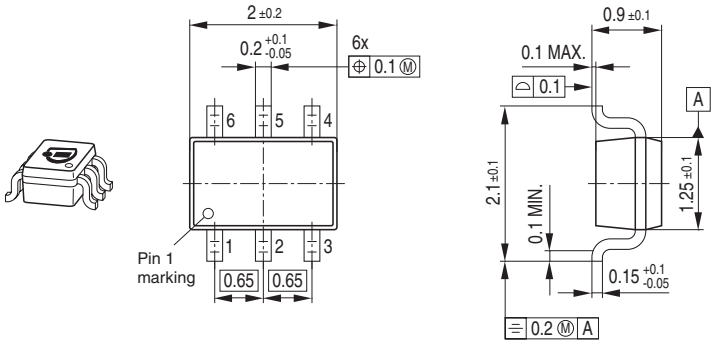
Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel

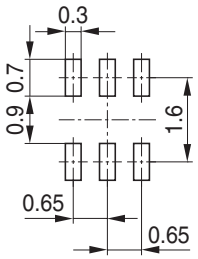


Downloaded from Arrow.com.

Package Outline

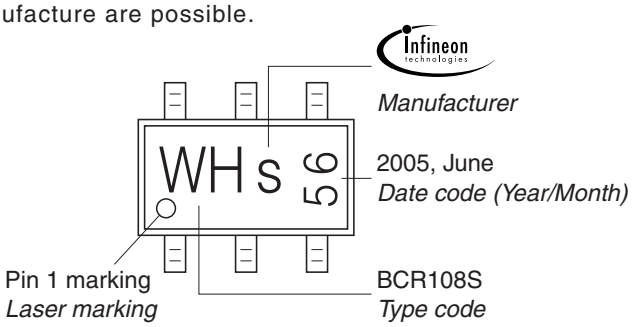


Foot Print



Marking Layout (Example)

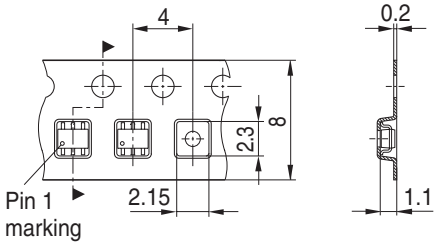
Small variations in positioning of
Date code, Type code and Manufacture are possible.



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel
Reel ø330 mm = 10.000 Pieces/Reel

For symmetric types no defined Pin 1 orientation in reel.



Downloaded from Arrow.com.

Edition 2009-11-16

Published by
Infineon Technologies AG
81726 Munich, Germany

© 2009 Infineon Technologies AG
All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest Infineon Technologies Office (<www.infineon.com>).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.
Infineon Technologies components may be used in life-support devices or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Downloaded from Arrow.com.